

N-CHANNEL POWER MOSFET

● **FEATURES**

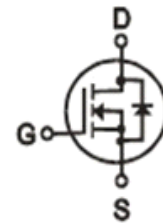
- LOW THERMAL RESISTANCE
- FAST SWITCHING
- HIGH INPUT RESISTANCE
- RoHS COMPLIANT

● **APPLICATION**

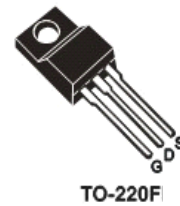
- ELECTRONIC BALLAST
- ELECTRONIC TRANSFORMER
- SWITCH MODE POWERSUPPLY

● **Absolute Maximum Ratings (Tc=25°C)**

PARAMETER	SYMBOL	VALUE	UNIT
Drain-source Voltage	V _{DS}	650	V
gate-source Voltage	V _{GS}	± 30	V
Continuous Drain Current TC=25°C	I _D	7.0	A
Continuous Drain Current TC=100°C	I _D	3.2	A
Drain Current – Pulsed ①	I _{DM}	28	A
Power Dissipation	P _{tot}	TO-220F:40	W
Junction Temperature	T _j	150	°C
Storage Temperature	T _{STG}	-55-150	°C
Single Pulse Avalanche Energy ②	E _{AS}	230	mJ



V_{DS}=650V
R_{DS(ON)}=1.4Ω
I_D=7.0A



● **Electronic Characteristics (Tc=25°C)**

PARAMETER	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
Drain-source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	650			V
Breakdown Voltage Temperature Coefficient	Δ BV _{DSS} /Δ T _j	I _D =250uA, Referenced to 25°C		0.8		V/°C
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} =V _{DS} , I _D =250μA	2.0		4.0	V
Drain-source Leakage Current	I _{DSS}	V _{DS} =650V, V _{GS} =0V, T _j =25°C			1	μA
		V _{DS} =520V, V _{GS} =0V, T _j =125°C			10	μA
Forward Transconductance	g _{fs}	V _{DS} =40V, I _D =3.5A ③		3.0		S

● Electrical Characteristics

PARAMETER	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
Gate-body Leakage Current ($V_{DS} = 0$)	I_{GSS}	$V_{GS} = \pm 30V$			± 100	nA
Static Drain-source On Resistance	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 3.5A$ ③		1.1	1.4	Ω
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = 25V$ $F = 1.0MHz$		955		pF
Turn -Off Delay Time	$T_d(off)$	$V_{DD} = 325V, I_D = 7.0A$ $R_G = 25\Omega$ ③		90		ns
Total Gate Charge	Q_g	$I_D = 7.0A, V_{DS} = 520V$ $V_{GS} = 10V$ ③		28		nC
Gate-to-Source Charge	Q_{gs}			7		nC
Gate-to-Drain Charge	Q_{gd}			12		nC
Continuous Diode Forward Current	I_S				7.0	A
Diode Forward Voltage	V_{SD}	$T_j = 25^\circ C, I_S = 7.0A$ $V_{GS} = 0V$ ③			1.4	V
Reverse Recovery Time	t_{rr}	$T_j = 25^\circ C, I_f = 7.0A$ $di/dt = 100A/\mu s$ ③		400		ns
Reverse Recovery Charge	Q_{rr}			3.3		μC

● Thermal Characteristics

PARAMETER	SYMBOL	MAX	UNIT
		TO-220F	
Thermal Resistance Junction-case	R_{thJC}	3.13	$^\circ C/W$
Thermal Resistance Junction-ambient	R_{thJA}	62.5	$^\circ C/W$

(Notes)

- ① Repetitive rating: Pulse width limited by maximum junction temperature
- ② Starting $T_j = 25^\circ C, V_{DD} = 50V, L = 10mH, R_G = 25\Omega, I_{AS} = 7.0A$
- ③ Pulse Test : Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$

• Typical Characteristics

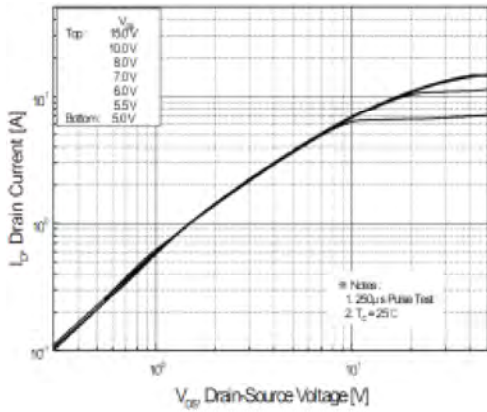


Fig.1 Typical Output Characteristics, $T_c=25^\circ\text{C}$

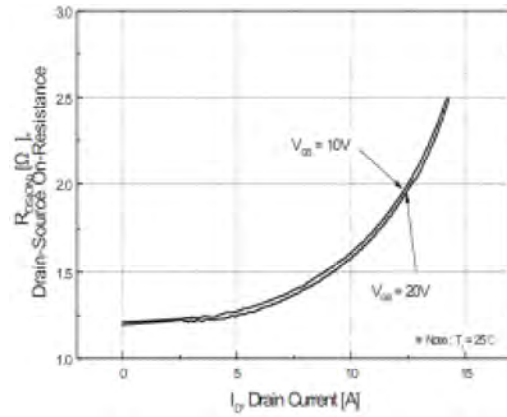


Fig.2 On-Resistance Vs. Drain Current and Gate Voltage

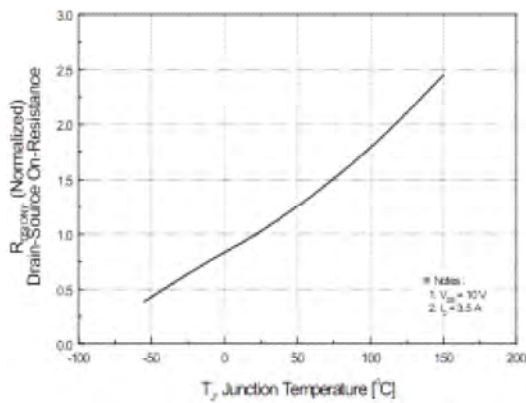


Fig.3 Normalized On-Resistance Vs. Temperature

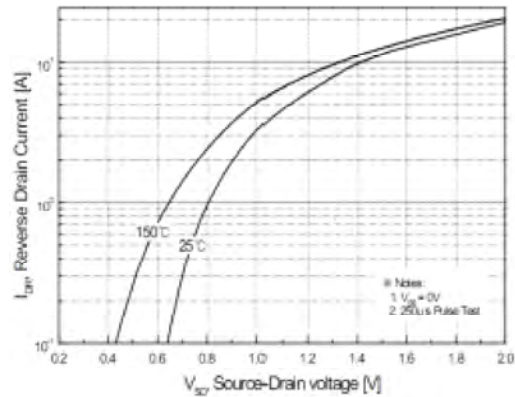


Fig.4 Typical Source-Drain Diode Forward Voltage

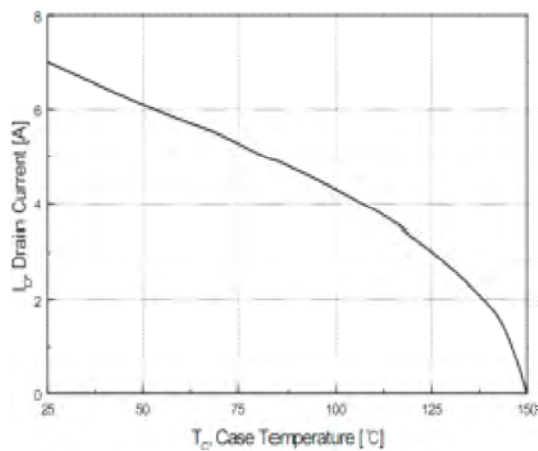


Fig.5 Maximum Drain Current Vs. Case Temperature

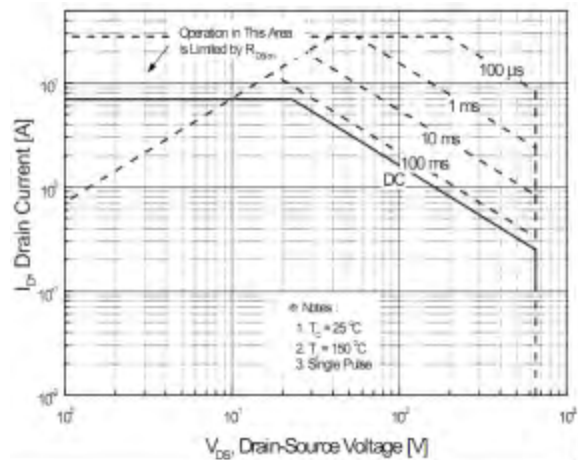


Fig.6 Maximum Safe Operating Area

TO-220F MECHANICAL DATA

UNIT: mm

SYMBOL	min	nom	max	SYMBOL	min	nom	max
A	4.40		4.95	e		2.54	
A ₁	2.30		2.90	L	12.50		14.30
b	0.45		0.90	L ₁	9.10		10.05
b ₁	1.10		1.70	L ₂	15.00		16.00
c	0.35		0.90	L ₃	3.00		4.00
D	14.50		17.00	øp	3.00		3.50
D ₁	6.10		9.00	Q	2.30		2.80
E	9.60		10.30				

